

PS9151 R08DS0108EJ0301 Rev.3.01 May 30, 2018

HIGH NOISE REDUCTION, 15 Mbps CMOS OUTPUT TYPE, 5-PIN SOP (SO-5) PHOTOCOUPLER

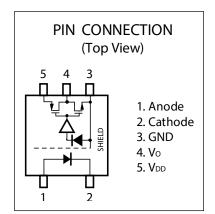
DESCRIPTION

The PS9151 is an optically coupled isolator containing an AlGaAs LED on the input side and a CMOS output IC on the output side.

This photocoupler is high common mode transient immunity (CMR), a high-speed CMOS output type device designed for high-speed logic interface circuits.

FEATURES

- High-speed response (15 Mbps)
- Operable at high temperature (-40 to +100°C)
- High common mode transient immunity (CM_H, CM_L = ± 20 kV/ μ s TYP.)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Pulse width distortion (|tphl tplh| = 3 ns TYP.)
- Ordering number of tape product: PS9151-F3: 2 500 pcs/reel
- Pb-Free product
- · Safety standards
 - UL approved: UL1577, Single protection • VDE approved: DIN EN 60747-5-5 (Option)

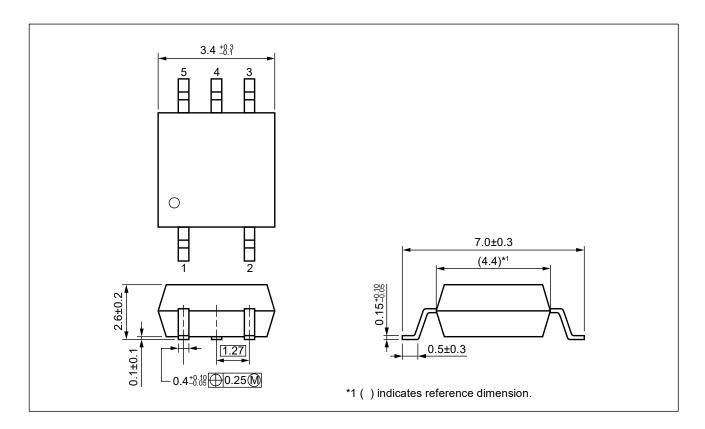


APPLICATIONS

- FA Network
- Measurement equipment

Start of mass production Jun.2006

PACKAGE DIMENSIONS (UNIT: mm)

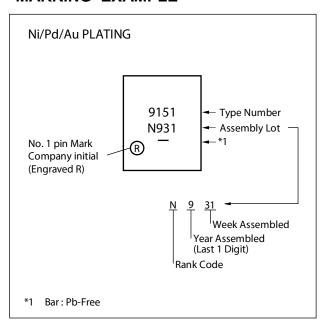


Weight: 0.08g (typ.)

PHOTOCOUPLER CONSTRUCTION

Parameter	PS9151
Air Distance (MIN.)	4.2 mm
Creepage Distance (MIN.)	4.2 mm
Isolation Distance (MIN.)	0.2 mm

MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS9151	PS9151-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9151
PS9151-F3	PS9151-F3-AX	(Ni/Pd/Au)	Embossed Tape 2 500 pcs/reel	(UL, approved)	
PS9151-V	PS9151-V-AX		20 pcs (Tape 20 pcs cut)	UL, DIN EN 60747-5-5	
PS9151-V-F3	PS9151-V-F3-AX		Embossed Tape 2 500 pcs/reel	approved	

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current *1	I _F	20	mA
	Reverse Voltage	V _R	5	V
Detector	Supply Voltage	V_{DD}	0 to 5.5	V
	Output Voltage	Vo	-0.5 to V _{DD} +0.5	V
	Output Current	lo	2	mA
Isolation Voltage*2		BV	3 750	Vr.m.s.
Operating Ambient Temperature		T _A	-40 to +100	°C
Storage Temperature		T_{stg}	-55 to +125	°C

Notes: *1. Reduced to 0.8 mA/°C at T_A = 95°C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Forward Current	lF	10		16	mA
Supply Voltage	V_{DD}	4.5	5.0	5.5	V

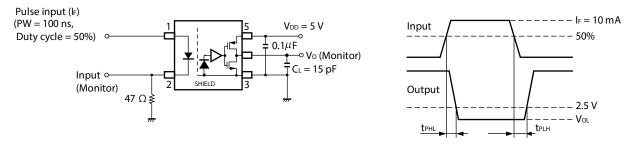
^{*2}. AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = -40 to $+100^{\circ}$ C, V_{DD} = 4.5 to 5.5 V, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA, T _A = 25°C	1.4	1.65	1.8	V
	Reverse Current	I _R	V _R = 3 V, T _A = 25°C			10	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Supply Current	I _{DDH}	I _F = 0 mA		2.5	5	mA
	Low Level Supply Current	I _{DDL}	I _F = 10 mA,		2	5	
	High Level Output Voltage	Іссн	$I_0 = -20 \ \mu\text{A}, I_F = 0 \text{ mA}$	4	5		V
	Low Level Output Voltage	VoL	$I_0 = 20 \ \mu\text{A}, I_F = 10 \text{ mA}$		0	0.1	
Coupled	Threshold Input Voltage	I _{FHL}	V _O < 1 V		2.2	5	mA
	Isolation Resistance	R _{I-O}	$V_{I-O} = 1 \text{ kV}_{DC}$, RH = 40 to 60%, $T_A = 25^{\circ}\text{C}$	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time $(H \rightarrow L)^{*2}$	t _{PHL}	I_F = 10 mA, V_{DD} = 5 V, C_L = pF, CMOS Levels		35	60	ns
	Propagation Delay Time $(L \rightarrow H)^{*2}$	t _{PLH}			35	60	
	Pulse Width Distortion (PWD)*2	t _{PHL} —t _{PLH}			3	30	
	Propagation Delay Skew	t psk				40	
	Rise Time	tr			4		
	Fall Time	t _f			4		
	Common Mode Transient Immunity at High Level Output*3	СМн	$V_{DD} = 5 \text{ V}, I_F = 0 \text{ mA},$ $V_{CM} = 1 \text{ kV}, V_O > 4 \text{ V},$ $T_A = 25^{\circ}\text{C}$	15	20		kV/μs
	Common Mode Transient Immunity at Low Level Output*3	CM _L	$V_{DD} = 5 \text{ V, I}_F = 10 \text{ mA,}$ $V_{CM} = 1 \text{ kV, V}_O < 1 \text{ V,}$ $T_A = 25^{\circ}\text{C}$	15	20		

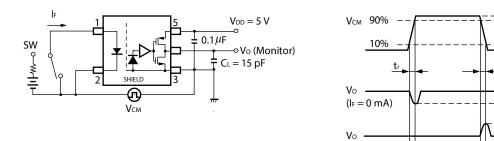
Notes: *1. Typical values at T_A = 25°C

*2. Test circuit for propagation delay time



Remark CL includes probe and stray wiring capacitance.

*3. Test circuit for common mode transient immunity



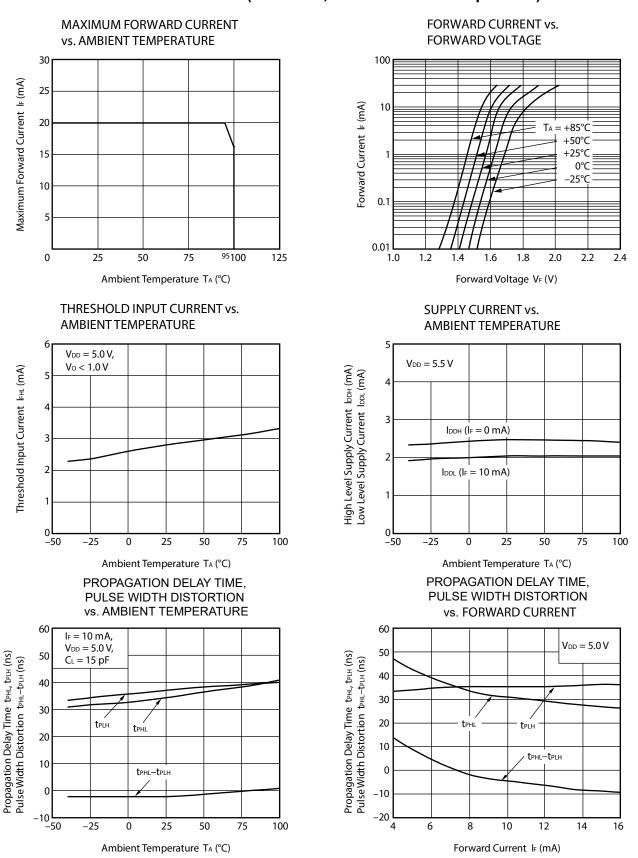
 $(I_F = 10 \text{ mA})$

Remark CL includes probe and stray wiring capacitance.

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F or more is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is 10 mm or less.
- 3. When V_{DD} is lower than around 2 V, the output(V_o) of this product is unstable, and this might produce undesirable operation. Be sure to check the operation of an IC or a discrete component that is connected to this product during Power-up and Power-down process. And we recommend to use a disable function (shutdown function) of the connected IC or a reset IC to avoid this undesirable operation.
- 4. Avoid storage at a high temperature and high humidity.
- 5. Do not use adhesives or coating materials including halogens to fix this device.

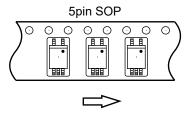
TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)



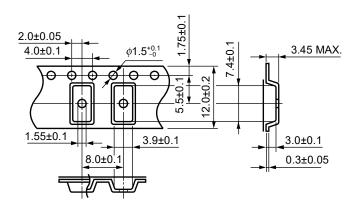
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

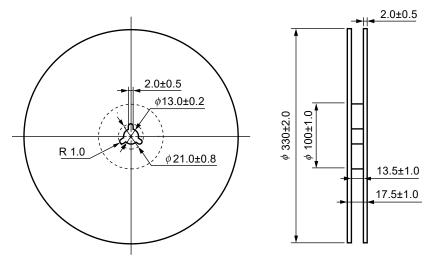




Outline and Dimensions (Tape)

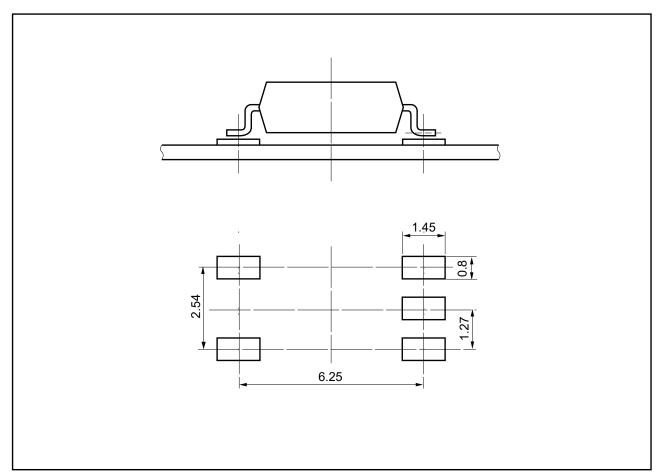


Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



[5pin SOP]

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

Peak reflow temperature 260°C or below (package surface temperature)

Time of peak reflow temperature 10 seconds or less

Time of temperature higher than 220°C 60 seconds or less

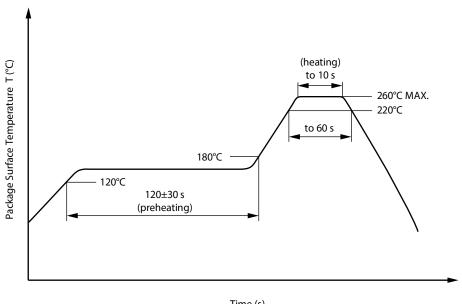
Time to preheat temperature from 120 to 180°C 120±30 s Number of reflows Three

Flux Rosin flux containing small amount of chlorine (The flux

with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

Temperature 260°C or below (molten solder temperature)

Time 10 seconds or less

Preheating conditions 120°C or below (package surface temperature)

Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt % is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350°C or below

Time (each pins) 3 seconds or less

Rosin flux containing small amount of chlorine (The flux with a Flux maximum chlorine content of 0.2 Wt % is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and halogens-based (chlorine-based) cleaning solvent .

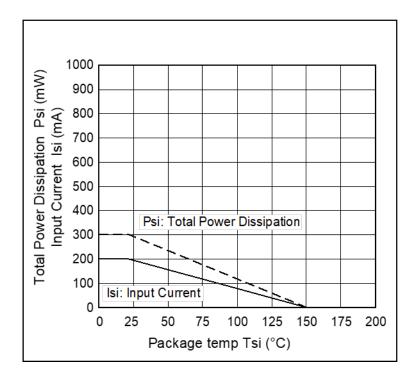
2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

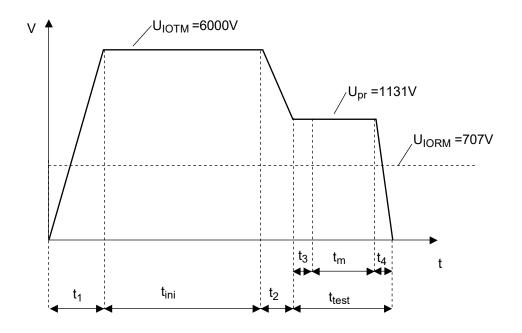
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/100/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	707	V_{peak}
Test voltage (partial discharge test, procedure a for type test and	Upr	1 131	V_{peak}
random test)			
$U_{pr} = 1.6 \times U_{IORM}, P_d < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	Upr	1 326	V_{peak}
$U_{pr} = 1.875 \times U_{IORM}, P_d < 5 pC$			
Highest permissible overvoltage	Utr	6 000	V_{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303	CTI	175	
Part 11))			
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T _{stg}	-55 to +125	°C
Operating temperature range	TA	-40 to +100	°C
Isolation resistance, minimum value			
V _{IO} = 500 V dc at T _A = 25°C	Ris MIN.	10 ¹²	Ω
V _{IO} = 500 V dc at T _A MAX. at least 100°C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see			
thermal derating curve)			
Package temperature	Tsi	150	°C
Current (input current I _F , P _{si} = 0)	lsi	200	mA
Power (output or total power dissipation)	Psi	300	mW
Isolation resistance			
V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

Dependence of maximum safety ratings with package temperature



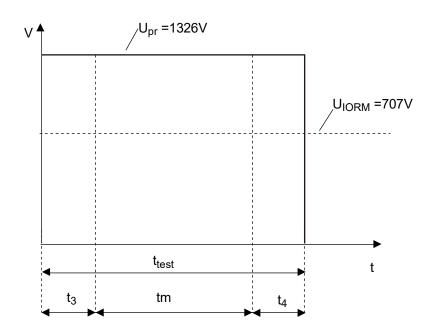
Method a) Destructive Test, Type and Sample Test



 $t_1, t_2 = 1$ to 10 sec $t_3, t_4 = 1$ sec $t_m(PARTIAL DISCHARGE) = 1$

 $t_{m(PARTIAL\ DISCHARGE)}$ = 10 sec t_{test} = 12 sec t_{ini} = 60 sec

Method b) Non-destructive Test, 100% Production Test



 t_3, t_4 = 0.1 sec $t_{m(PARTIAL\ DISCHARGE)}$ = 1.0 sec t_{test} = 1.2 sec

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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(Rev.4.0-1 November 2017)



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